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Thank you for your cooperation and understanding,

WeEn Semiconductors



# **BYQ28 series E and ED**

# Rectifier diodes ultrafast, rugged Rev. 04 — 5 December 2007

**Product data sheet** 

#### 1. **Product profile**

### 1.1 General description

Ultrafast, dual common cathode, epitaxial rectifier diodes in a SOT78 (TO-220AB) and a SOT428 (DPAK) plastic package.

### 1.2 Features

- Fast switching
- Soft recovery characteristic
- Reverse surge capability
- Low thermal resistance
- Low forward voltage drop
- High thermal cycling performance

### 1.3 Applications

Output rectifiers in high-frequency switched-mode power supplies

#### 1.4 Quick reference data

- $V_{RRM} \le 200 \text{ V}$
- $V_F \le 0.895 \text{ V}$

- $I_{O(AV)} \le 10 A$
- $t_{rr} = 10 \text{ ns (typ)}$

# **Pinning information**

Table 1. **Pinning** 

Pin	Description	Simplified outline	Symbol		
1	anode 1				
2	cathode	[1] mb	mb 1 3		
3	anode 2	7 9 5			
mb	mounting base; cathode	1 2 3	sym084 1 3 SOT428 (DPAK)		
		SOT78 (3-lead TO-220AB)			

[1] It is not possible to connect to pin 2 of the SOT428 package.



# 3. Ordering information

Table 2. Ordering information

Type number	Package					
	Name	Description	Version			
BYQ28E-200	TO-220AB	plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB	SOT78			
BYQ28ED-200	DPAK	plastic single-ended surface-mounted package (DPAK); 3-leads (one lead cropped)	SOT428			

# 4. Limiting values

### Table 3. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

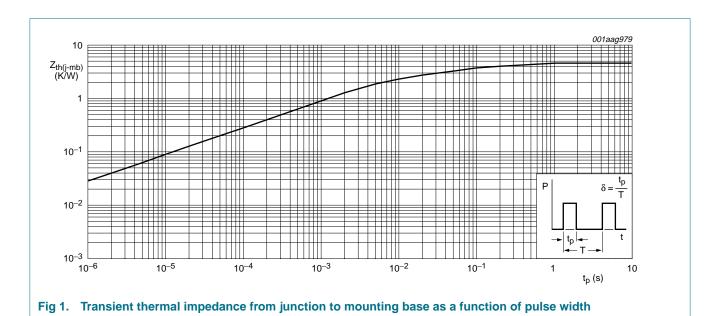
Symbol	Parameter	Conditions	Min	Max	Unit
$V_{RRM}$	repetitive peak reverse voltage		-	200	V
$V_{RWM}$	crest working reverse voltage		-	200	V
$V_R$	reverse voltage	square waveform; $\delta = 1.0$	-	200	V
I <sub>O(AV)</sub>	average output current	square waveform; $\delta$ = 0.5; $T_{mb} \le 119$ °C; both diodes conducting	-	10	Α
I <sub>FRM</sub>	repetitive peak forward current	$t_p$ = 25 µs; square waveform; $\delta$ = 0.5; $T_{mb} \le$ 119 °C; per diode	-	10	Α
I <sub>FSM</sub>	non-repetitive peak forward current	t = 10 ms; sinusoidal waveform; per diode	-	50	Α
		t = 8.3 ms; sinusoidal waveform; per diode	-	55	Α
I <sub>RM</sub>	peak reverse recovery current	$t_p = 2 \ \mu s; \ \delta = 0.001$	-	0.2	Α
I <sub>RSM</sub>	non-repetitive peak reverse current	$t_p = 100 \ \mu s$	-	0.2	Α
T <sub>stg</sub>	storage temperature		-40	+150	°C
Tj	junction temperature		-	150	°C
Electrosta	atic discharge				
$V_{ESD}$	electrostatic discharge voltage	all pins; human body model; C = 250 pF; R = 1.5 k $\Omega$	-	8	kV

### 5. Thermal characteristics

Table 4. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	with heatsink compound; per diode; see Figure 1	-	-	4.5	K/W
		with heatsink compound; both diodes conducting	-	-	3	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air; SOT78	-	60	-	K/W
		SOT428	[1] -	50	-	K/W

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

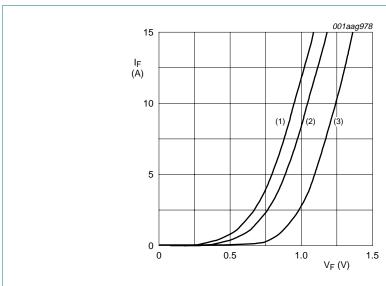


### 6. Characteristics

Table 5. Characteristics

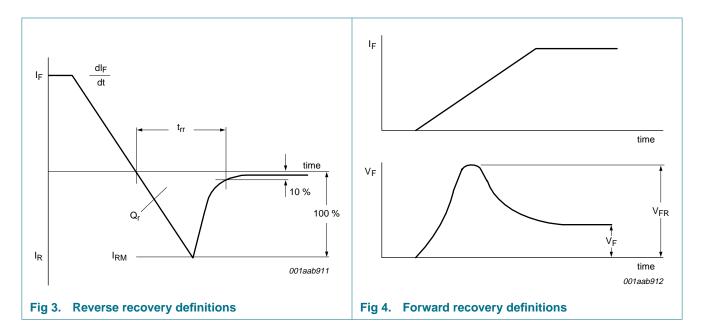
 $T_i = 25 \,^{\circ}C$  unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics					
V <sub>F</sub>	forward voltage	$I_F = 5 \text{ A}$ ; $T_j = 150 ^{\circ}\text{C}$ ; see Figure 2	-	0.8	0.895	V
		I <sub>F</sub> = 5 A; see <u>Figure 2</u>	-	0.95	1.1	V
		I <sub>F</sub> = 10 A; see <u>Figure 2</u>	-	1.1	1.25	V
I <sub>R</sub>	reverse current	V <sub>R</sub> = 200 V	-	2	10	μΑ
		$V_R = 200 \text{ V}; T_j = 100 ^{\circ}\text{C}$	-	0.1	0.2	mA
Dynamic o	characteristics					
Q <sub>r</sub>	recovered charge	$I_F$ = 2 A to $V_R$ $\geq$ 30 V; $dI_F/dt$ = 20 A/ $\mu$ s; see Figure 3	-	4	9	nC
t <sub>rr</sub>	reverse recovery time	ramp recovery; $I_F = 1$ A to $V_R \ge 30$ V; $dI_F/dt = 100$ A/ $\mu$ s; see Figure 3	-	15	25	ns
		step recovery; when switched from $I_F = 0.5 \text{ A}$ to $I_R = 1 \text{ A}$ ; measured at $I_R = 0.25 \text{ A}$	-	10	20	ns
I <sub>RM</sub>	peak reverse recovery current	$I_F$ = 5 A to $V_R$ $\geq$ 30 V; $dI_F/dt$ = 50 A/ $\mu$ s; see Figure 3	-	0.5	0.7	Α
$V_{FR}$	forward recovery voltage	$I_F = 1 \text{ A}$ ; $dI_F/dt = 10 \text{ A/}\mu\text{s}$ ; see Figure 4	-	1	-	V



- (1)  $T_j = 150 \,^{\circ}\text{C}$ ; typical values
- (2)  $T_i = 150 \,^{\circ}C$ ; maximum values
- (3)  $T_j = 25$  °C; maximum values

Fig 2. Forward current as a function of forward voltage



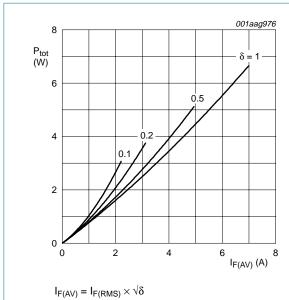


Fig 5. Forward power dissipation as a function of average forward current; square waveform; maximum values

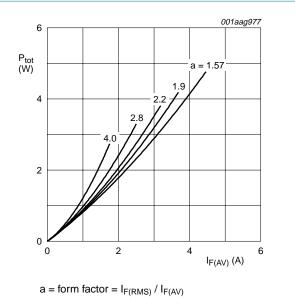
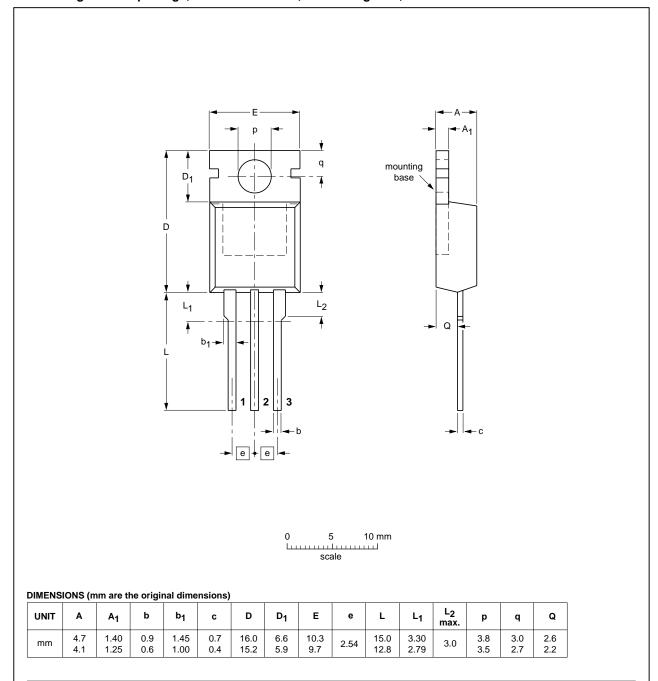


Fig 6. Forward power dissipation as a function of average forward current; sinusoidal waveform; maximum values

## 7. Package outline

Plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB

SOT78



OUTLINE		REFER	ENCES		EUROPEAN PROJECTION	ISSUE DATE
VERSION	IEC	JEDEC	JEITA			ISSUE DATE
SOT78		3-lead TO-220AB	SC-46			<del>05-03-22</del> 05-10-25

Fig 7. Package outline SOT78 (TO-220AB)

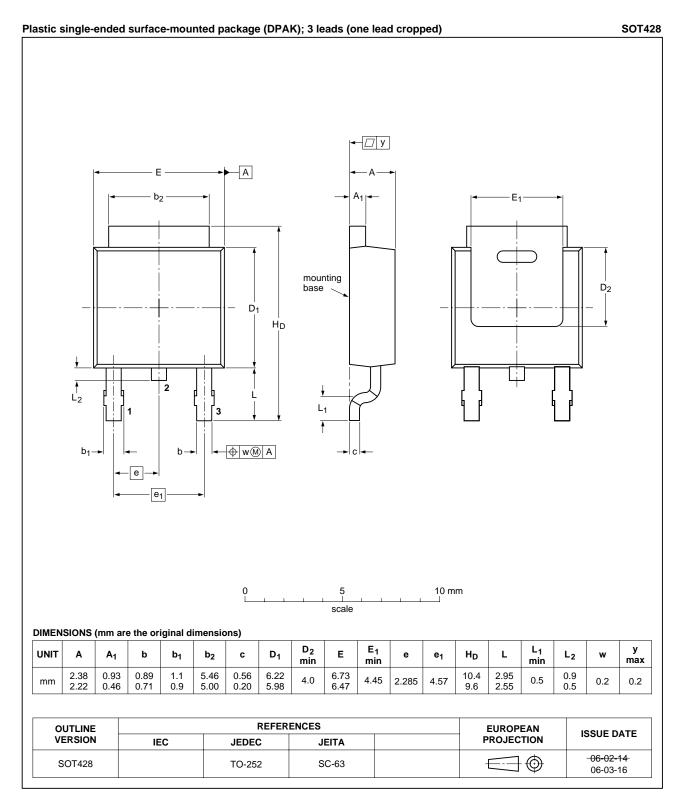


Fig 8. Package outline SOT428 (TO-252)

# 8. Revision history

### Table 6. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BYQ28_SER_E_ED_4	20071205	Product data sheet	-	BYQ28E_SERIES_3
Modifications:		t of this data sheet has been of NXP Semiconductors.	en redesigned to com	nply with the new identity
	<ul> <li>Legal texts</li> </ul>	have been adapted to the	e new company name	where appropriate.
	•	lues table: some paramete I <sub>FRM</sub> conditions amended	•	ded to conform to latest
		stics: $Q_{rr}$ changed to $Q_r$ 'revery' and 'step recovery' a	_	and t <sub>rr2</sub> changed to t <sub>rr</sub> with
BYQ28E_SERIES_3	19981001	Product specification	-	BYQ28E_SERIES_2
BYQ28E_SERIES_3 BYQ28E_SERIES_2	19981001 19980701	Product specification Product specification	-	BYQ28E_SERIES_2 BYQ28E_SERIES_1; BYQ28EB_SERIES_1

# **BYQ28 series E and ED**

Rectifier diodes ultrafast, rugged

### 9. Legal information

#### 9.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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### **NXP Semiconductors**

# **BYQ28 series E and ED**

Rectifier diodes ultrafast, rugged

### 11. Contents

1	Product profile
1.1	General description
1.2	Features
1.3	Applications
1.4	Quick reference data 1
2	Pinning information
3	Ordering information
4	Limiting values 2
5	Thermal characteristics 3
6	Characteristics 4
7	Package outline 6
8	Revision history 8
9	Legal information 9
9.1	Data sheet status 9
9.2	Definitions
9.3	Disclaimers
9.4	Trademarks9
10	Contact information 9
11	Contents

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.



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